

High-performance Clock Generator Series

Compact 1ch Clock Generators for Digital Cameras

BU3071HFV,BU3072HFV,BU3073HFV,BU3076HFV,BU7322HFV,BU7325HFV

No.09005EAT01

Description

These Clock Generators incorporates compact package compared to oscillators, which provides the generation of high-frequency CCD, USB, VIDEO clocks necessary for digital still cameras and digital video cameras.

Features

- 1) SEL pin allowing for the selection of frequencies
- 2) Selection of OE pin enabling Power-down function
- 3) Crystal-oscillator-level clock precision with high C/N characteristics and low jitter
- 4) Micro miniature HVSOF6 Package incorporated
- 5) Single power supply of 3.3 V

Applications

Digital Still Camera, Digital Video Camera, and others

●Lineup

Parameter	BU3071HFV	BU3072HFV	BU3073HFV	BU3076HFV	BU7322HFV	BU7325HFV
Supply voltage	3.0 V ~ 3.6V	3.0 V ~ 3.6V	3.0 V ~ 3.6V	2.85 V ~ 3.6V	2.85 V ~ 3.6V	2.85 V ~ 3.6V
Operating temperature range	-5°C ~ 70°C	-5°C ~ 70°C	-5°C ~ 70°C	-5°C ~ 75°C	-5°C ~ 75°C	-30°C ~ 85°C
Reference input clock	28.6363MHz	48.0000MHz	48.0000MHz	27.0000MHz	27.0000MHz	27.0000MHz
	54.0000MHz	27.0000MHz	24.3750MHz	54.0000MHz	49.5000MHz	48.0000MHz
	-	36.0000MHz	24.5454MHz	67.5000MHz	36.0000MHz	78.0000MHz
Power-down function	Provided	Provided	Provided	Provided	Provided	Provided
Operating current (Typ.)	10mA	11mA	11mA	12mA	10mA	12mA
Package	HVSOF6	HVSOF6	HVSOF6	HVSOF6	HVSOF6	HVSOF6

●Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Ratings	Unit
Supply voltage	VDD -0.3 ~ 4.0		V
Input voltage	VIN	-0.3 ~ VDD+0.3	V
Storage temperature range	Tstg	-30 ~ 125	°C
Power dissipation	Pd	410	mW

*1 Operating is not guaranteed.

*2 In the case of exceeding Ta = 25° C, 4.1mW should be reduced per 1°C.

*3 The radiation-resistance design is not carried out.

*4 Power dissipation is measured when the IC is mounted to the printed circuit board.

Recommended Operating Range

Parameter	Symbol	Limits	Unit
Supply voltage	VDD	3.0 ~ 3.6	V
Input H voltage	VINH	0.8VDD ~ VDD	V
Input L voltage	VINL	0.0 ~ 0.2VDD	V
Operating temperature	Topr	-5 ~ 70	°C
Output load	CL	15(MAX)	pF

•Electrical Characteristics

BU3071HFV(Ta=25°C, VDD=3.3V,Crystal frequency=28.6363MHz, unless otherwise specified.)

Deremeter	Sumbol	Limits			Linit	Conditions	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA	
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA	
Consumption current 1	IDD1	-	10	15	mA	OE=H, at no load	
Consumption current 2	IDD2	-	1	1.3	mA	OE=L	
Output frequency		-	54.0000	-	MHz	IN*264/35/4	
The following parameters r	epresent de	esign guara	anteed perf	ormance.			
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD	
Period-Jitter 1o	PJsSD	-	50	-	psec	※ 1	
Period-Jitter MIN-MAX	PJsABS	-	300	-	psec	*2	
Rise time	tr	-	2.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.	
Fall time	tf	-	2.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.	
Output Lock time	tLOCK	-	-	1	msec	*3	

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN.

If the input frequency is set to 28.6363MHz, the output frequency will be as listed above.

BU3072HFV(Ta=25°C, VDD=3.3V, Crystal frequency=48.0000MHz, unless otherwise specified.)

Deremeter	Symbol	Limits			Lloit	Conditions	
Falametei	Symbol	Min.	Тур.	Max.	Onit	Conditions	
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA	
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA	
Consumption current 1	IDD1	-	11	16	mA	PD=H, at no load	
Consumption current 2	IDD2	-	-	5	μA	PD=L	
Output fraguanay	CLK_27	-	27.0000	-	MHz	SEL=L, IN*18/8/4	
Output frequency	CLK_36	-	36.0000	-	MHz	SEL=H, IN*24/8/4	
The following parameters	represent de	esign guar	anteed per	formance.			
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD	
Period-Jitter 1o	PJsSD	-	35	-	psec	※ 1	
Long-Term-Jitter MIN-MAX	LTJsABS	-	0.9	1.5	nsec	MIN-MAX of long-term jitter (100 μsec from trigger)	
Rise time	tr	-	2.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.	
Fall time	tf	-	2.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.	
Output Lock time	tLOCK	-	-	1	msec	*3	

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN. If the input frequency is set to 48.0000MHz, the output frequency will be as listed above.

Doromotor	Symbol	Limits			Linit	Conditions
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA
Consumption current 1	IDD1	-	11	16	mA	PD=H, at no load
Consumption current 2	IDD2	-	-	5	mA	PD=L
Output fraguanay	CLK_375	-	24.3750	-	MHz	SEL=L, IN*65/16/8
Output frequency	CLK_545	-	24.5454	-	MHz	SEL=H, IN*45/11/8
The following parameters	represent de	esign guar	anteed per	formance.		
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD
Period-Jitter 1o	PJsSD	-	45	-	psec	※ 1
Long-Term-Jitter MIN-MAX	LTJsABS	-	0.9	1.5	nsec	MIN-MAX of long-term jitter (100 μsec from trigger)
Rise time	tr	-	2.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.
Fall time	tf	-	2.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.
Output Lock time	tLOCK	-	-	1	msec	*3

BU3073HFV(Ta=25°C, VDD=3.3V, Crystal frequency=48.0000MHz, unless otherwise specified.)

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN. If the input frequency is set to 48.0000MHz, the output frequency will be as listed above.

BU3076HFV(Ta=25°C, VDD=3.3V, Crystal frequency=27.0000MHz, unless otherwise specified.)

Deremeter	Symbol		Limits		Lloit	Conditions	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA	
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA	
Pull-down resistance	Rpd	25	50	100	KΩ	Pull-down resistance on input pin	
Consumption current 1	IDD1	-	10	15	mA	54MHz output, at no load	
Consumption current 2	IDD2	-	12	18	mA	67.5MHz output, at no load	
Standby current	IDDst	-	-	1	μA	OE=L	
Output fraguanay	CLK_54	-	54.0000	-	MHz	SEL=L, IN*48/6/4	
Output frequency	CLK_67.5	-	67.5000	-	MHz	SEL=H, IN*60/6/4	
The following parameters r	epresent de	esign guara	anteed per	formance.			
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD	
Period-Jitter 1o	PJsSD	-	50	-	psec	※ 1	
Period-Jitter MIN-MAX	PJsABS	-	300	-	psec	*2	
Rise time	tr	-	1.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.	
Fall time	tf	-	1.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.	
Output Lock time	tLOCK	-	-	200	µsec	*3	

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN. If the input frequency is set to 27.0000MHz, the output frequency will be as listed above.

Doromotor	Symbol	Limits			1.1	Canditions
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA
Pull-down resistance	Rpd	25	50	100	kΩ	Pull-down resistance on input pin
Consumption current 1	IDD	-	10	13.5	mA	49.5MHz output, at no load
Consumption current 2	IDD2	-	9.5	13.0	mA	36.0MHz output, at no load
Standby current	IDDst	-	-	1	μA	OE=L
Output fraguanay	CLK_49.5	-	49.5000	-	MHz	SEL=L, IN*66/6/6
Output frequency	CLK_36	-	36.0000	-	MHz	SEL=H, IN*64/6/8
The following parameters re	epresent de	sign guara	anteed perf	ormance.		
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD
Period-Jitter 1 σ	PJsSD	-	50	-	psec	※ 1
Period-Jitter MIN-MAX	PJsABS	-	300	-	psec	*2
Rise time	tr	-	2.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.
Fall time	tf	-	2.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.
Output Lock time	tLOCK	-	-	200	µsec	*3

BU7322HFV(Ta=25°C, VDD=3.3V, Crystal frequency=27.0000MHz, unless otherwise specified.)

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN.

If the input frequency is set to 27.0000MHz, the output frequency will be as listed above.

BU7325HFV(Ta=25°C, VDD=3.3V, Crystal frequency=27.0000MHz, unless otherwise specified.)

Deremeter	Sumbol	Limits			Linit	Conditiona	
Farameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Output H voltage	VOH	2.8	-	-	V	IOH=-4.0mA	
Output L voltage	VOL	-	-	0.5	V	IOL=4.0mA	
Pull-down resistance	Rpd	25	50	100	kΩ	Pull-down resistance on input pin	
Consumption current 1	IDD1	-	11	15	mA	OE=H, SEL=L, at no load	
Consumption current 2	IDD2	-	12	16.5	mA	OE=H, SEL=H, at no load	
Standby current	IDDst	-	-	1	μA	OE=L	
Output fraguanau	CLK_48	-	48.0000	-	MHz	SEL=L, IN*96/9/6	
Output frequency	CLK_78	-	78.0000	-	MHz	SEL=H, IN*104/9/4	
The following parameters re	epresent de	esign guar	anteed per	formance.		·	
Duty	Duty	45	50	55	%	Measured at a voltage of 1/2 of VDD	
Period-Jitter 1o	PJsSD	-	50	-	psec	※1	
Period-Jitter MIN-MAX	PJsABS	-	300	-	psec	※ 2	
Rise time	tr	-	1.5	-	nsec	Period of transition time required for the output to reach 80% from 20% of VDD. Provided with 15pF output load.	
Fall time	tf	-	1.5	-	nsec	Period of transition time required for the output to reach 20% from 80% of VDD. Provided with 15pF output load.	
Output Lock time	tLOCK	-	-	200	µsec	*3	

Note) The output frequency is determined by the arithmetic (frequency division) expression of a frequency input to IN.

If the input frequency is set to 27.0000MHz, the output frequency will be as listed above.

Common to BU3071HFV, BU3072HFV, BU3073HFV, BU3076HFV, BU7322HFV, BU7325HFV

%1 Period-Jitter 1σ

This parameter represents standard deviation (=1σ) on cycle distribution data at the time when the output clock cycles are sampled 1000 times consecutively with the TDS7104 Digital Phosphor Oscilloscope of Tektronix Japan, Ltd. 2 Period-Jitter MIN-MAX

This parameter represents a maximum distribution width on cycle distribution data at the time when the output clock cycles are sampled 1000 times consecutively with the TDS7104 Digital Phosphor Oscilloscope of Tektronix Japan, Ltd.

3 Output Lock Time This parameter represents elapsed time after power supply turns ON to reach a voltage of 3.0 V, after the system is switched from Power-Down state to normal operation state, or after the output frequency is switched, until it is stabilized at a specified frequency, respectively.

Technical Note

Reference data (BU3071HFV basic data)



Fig.1 54MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)

Reference data (BU3072HFV basic data)



Fig.2 54MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.3 54MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.4 27MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.7 36MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.5 27MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.8 36MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.6 27MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.9 36MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)

Reference data (BU3073HFV basic data)



Fig.10 24.375MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.13 24.5454MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)

Reference data (BU3076HFV basic data)



Fig.16 54MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.19 67.5MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.11 24.375MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.14 24.5454MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.12 24.375MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.15 24.5454MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C



Fig.17 54MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.20 67.5MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.18 54MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.21 67.5MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)

Reference data (BU7322HFV basic data)



Fig.22 49.5MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.25 36MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)

Reference data (BU7325HFV basic data)



Fig.28 48MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.31 78MHz output waveform (VDD=3.3V,CL=15pF,Ta=25°C



Fig.23 49.5MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.26 36MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.24 49.5MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.27 36MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.29 48MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)

1V/div



Fig.32 78MHz Period-Jitter (VDD=3.3V,CL=15pF,Ta=25°C)



Fig.30 48MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C



Fig.33 78MHz spectrum (VDD=3.3V,CL=15pF,Ta=25°C)

100



Reference data (BU3071HFV Temperature and Supply voltage variations data)



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temperature characteristics

temperature characteristics







Block diagram, pin assignment/functions (BU3071HFV)



Fig.89

PIN	PIN	Function
NO.	name	Function
1	VDD	Power supply
2	VSS	GND
3	OUT	Clock output terminal
4	OE	Output enable (L: disable, H: enable), equipped with Pull-down function, output fixed to L at disable
5	TEST	TEST pin, equipped with Pull-down function
6	IN	Clock input pin (28.6363 MHz input)

(BU3072HFV)



Fig.91



Fig.90

PIN	PIN	Function
NO.	name	FUICION
1	VDD	Power supply
2	VSS	GND
3	OUT	Clock output terminal (L:27.0000MHz, H:36.0000MHz)
4	PD	Power-down (L: Hi-Z, H: enable), equipped with Pull-down function, output set to Hi-Z at disable
5	SEL	Output selection (L: 27.0000 MHz, H: 36.0000 MHz)
6	IN	Clock input pin (48.0000 MHz input)

(BU3073HFV)



Fig.94

PIN	PIN	Function
NO.	name	FUICION
1	VDD	Power supply
2	VSS	GND
3	OUT	Clock output terminal (L:24.3750MHz, H:24.5454MHz)
4	PD	Power-down (L: disable, H: enable), equipped with Pull-down function, output set to L at disable
5	SEL	Output selection (L:24.3750MHz, H:24.5454MHz)
6	IN	Clock input pin (48.0000MHz input)

BU3071HFV,BU3072HFV,BU3073HFV,BU3076HFV,BU7322HFV,BU7325HFV **Technical Note**

(BU3076HFV) PLL 1/4 ■ 3pin:OUT 6pin:IN DATA1 DATA2 1:VDD 6:IN \bigcirc 2:VSS 5:SEL 5pin:SEL 3:0UT 4:0E 4pin:OE Fig.96

Fig.95

PIN	PIN	Function		
NO.	name	Function		
1	VDD	Power supply		
2	VSS	GND		
3	OUT	Clock output terminal (L:54.0000MHz, H:67.5000MHz)		
4	OE	Power-down (L: disable, H: enable), equipped with Pull-down function, output set to L at disable		
5	SEL	Output selection (L:54.0000MHz, H:67.5000MHz)		
6	IN	Clock input pin (27.0000MHz input)		





Fig.97

PIN	PIN	Function		
NO.	name	FUICION		
1	VDD	Power supply		
2	VSS	GND		
3	OUT	Clock output terminal (L:49.5000MHz, H:36.0000MHz)		
4	OE	Power-down (L:disable ,H:enable) equipped with Pull-down function, disable output set to L at disable		
5	SEL	Output selection (L:49.5000MHz, H:36.0000MHz) equipped with Pull-down function		
6	IN	Clock input pin (27.0000MHz input)		

(BU7325HFV)





Fig.99

0		19.100		
PIN	PIN	Function		
NO.	name			
1	VDD	Power supply		
2	VSS	GND		
3	OUT	Clock output terminal (L:48.0000MHz, H:78.0000MHz)		
4	OE	Power-down (L:disable ,H:enable) equipped with Pull-down function, disable output set to L at disable		
5	SEL	Output selection (L:48.0000MHz, H:78.0000MHz)		
6	IN	Clock input pin (27.0000MHz input)		

•Application circuit example



 \ast For VDD and VSS, insert a bypass capacitor of approx. 0.1 μF as close as possible to the pin.

* Bypass capacitors with good high-frequency characteristics are recommended.

* Even though we believe that the typical application circuit is worth of a recommendation, please be sure to thoroughly recheck the characteristics before use.

BU3071HFV,BU3072HFV,BU3073HFV,BU3076HFV,BU7322HFV,BU7325HFV

●Equivalent circuit

3-pin (Output pin)





Fig.107 BU3071HFV, BU3073HFV, BU3076HFV BU7322HFV, BU7325HFV Fig.108 BU3072HFV

4-pin (Input pin)



Fig.109

5-pin (Input pin)





Appearance of Marker





Fig.114

(UNIT : mm)

List of markers

Model name	Marker	
BU3071HFV	AB	
BU3072HFV	AC	
BU3073HFV	AD	
BU3076HFV	AA	
BU7322HFV	AE	
BU7325HFV	AH	

Notes for use

1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as applied voltage (VDD or VIN), operating temperature range (Topr), etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

2) Recommended operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines.

In this regard, for the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

Ordering part number



HVSOF6



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 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

Precaution Regarding Intellectual Property Rights

- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data. ROHM shall not be in any way responsible or liable for infringement of any intellectual property rights or other damages arising from use of such information or data.:
- 2. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the information contained in this document.

Other Precaution

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- 3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
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